

27.02.2025

GENERAL SPECIFICATION

MODULE NO. :

DEM 128064I FGH-PW

CUSTOMER P/N:

Version NO.	Change Description	Date
0	Original Version	23.12.2008
1	Update B/L Voltage And Drawing Remark	09.01.2009
2	Update Module Drawing	07.05.2009
3	Change UL	29.03.2013
4	Change Customer P/N	19.08.2013
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6	Add Version	15.06.2017
7	Change Backlight Description	26.02.2025
8	Change Backlight Description	27.02.2025

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1. FUNCTIONS & FEATURES

Module	LCD Type
DEM 128064I FGH-PW	FSTN Transflective Positive Mode
• Viewing Direction	: 6 O'clock
• Driving Scheme	: 1/65 Duty Cycle, 1/9 Bias
• Power Supply Voltage	: 3.3 Volt (typ.)
• LCD Operation Voltage(V0)-VSS) : 9.0 Volt (typ.)
• Driver IC	: ST7565P (Sitronix)
• Display Contents	: 128x 64 Dots
• Interface	: Parallel & Serial
• Operating Temperature	: -20°C to +70°C
• Storage Temperature	: -30°C to +80°C
• RoHS	: Compliant

2. MECHANICAL SPECIFICATIONS

•	Module Size (Without FPC)	: 55.20 x 39.80 x 5.00 mm
•	View Area	: 45.20 x 27.00 mm
•	Active Area	: 40.94 x 24.30 mm
•	Dot Size	: 0.30 x 0.36 mm
•	Dot Pitch	: 0.32 x 0.38 mm
•	Dot Gap	: 0.02 mm

3. EXTERNAL DIMENSIONS (⊕ unit: mm)



4. BLOCK DIAGRAM



5. PIN ASSIGNMENT

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		terminal.
20	VSS	Ground
21	VDD	Power supply
22	D7	
23	D6	This is an 8-bit bi-directional data bus that connects to an 8-bit or 16-bit standard
24	D5	MPU data bus.
25	D4	When the serial interface (SPI-4) is selected ($P/S = "L"$):
26	D3	D7 : serial data input (SI) ; D6 : the serial clock input (SCL).
27	D2	D0 to D5 should be connected to VDD or floating.
28	D1	When the chip select is not active, D0 to D7 are set to high impedance.
29	D0	
30	/RD (E)	 When connected to 8080 series MPU, this pin is treated as the "/RD" signal of the 8080 MPU and is LOW-active. The data bus is in an output status when this signal is "L". When connected to 6800 series MPU, this pin is treated as the "E" signal of the 6800 MPU and is HIGH-active. This is the enable clock input terminal of the 6800 Series MPU. When connected to 8080 series MPU, this pin is treated as the "/WR" signal of the 8080 MPU and is LOW-active.
31	/WR (R/W)	The signals on the data bus are latched at the rising edge of the /WR signal. • When connected to 6800 series MPU, this pin is treated as the "R/W" signal of the 6800 MPU and decides the access type : When R/W = "H": Read. When R/W = "L": Write.
32	A0	This is connected to the least significant bit of the normal MPU address bus, and it determines whether the data bits are data or a command. A0="HIGH": indicates that D0 to D7 are display data. A0=":LOW": indicates that D0 to D7 are control data.
33	/RES	When /RES is set to LOW, the settings are initialed. The reset operation is performed by the /RES signal level.
34	/CS1	This is the chip select signal for first chip. when /CS1=LOW, the chip select becomes active and the data/commands I/O is enabled
35	Κ	LED-
36	A	LED+

6. ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Conditions	Unit
Power Supply Voltage	VDD	0.3 ~ 3.6	V
Power Supply Voltage (VDD standard)	VDD2	0.3 ~ 3.6	V
Power Supply Voltage (VDD standard)	V0, VOUT	0.3 ~ 14.5	V
Power Supply Voltage (VDD standard)	V1, V2, V3, V4	V0 to 0.3	V
Operating Temperature	Topr	-20 to +70	°C
Storage Temperature	Tstr	-30 to +80	°C

7. BACKLIGHT ELECTRONICS/OPTICAL SPECIFICATIONS

Electronics/Optical Specifications: (Color: White)

P = P = P = P = P = P = P = P = P									
	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS			
Forward Voltage	Vf	2.7	3.1	4.0	V				
Forward Current	If		45		mA				
Power Dissipation	Pd			0.21	W	If=45mA			
Luminous Intensity	Lv	800			cd/m²				
Luminous Uniformity	Avg	70			%				
Reverse Voltage	VR			5	V				
Reverse Current	IR			0.1	mA	Vr=5V			
Colon Chromoticity	Х	0.26		0.33		If=20mA Ta=25°C			
Color Chromatienty	Y	0.26		0.33		Each chip			



8. DC CHARACTERISTICS

Itom	Symbol	Standard Value			Test Condition	Unit	
Item	Symbol	Min.	Тур.	Max.	Test Condition	Unit	
Power supply Voltage	V _{DD}	3.0	3.3	3.6		V	
Operating Voltage	V _{LCD}	8.7	9.0	9.3	V0-V _{SS}		
Current Consumption	I _{DD}		170	255		uA	

9. AC ELECTRICAL CHARACTERISTICS

9.1 System bus READ/WRITE characteristics for the 8080 series MPU

(VDD=3.3V, VSS=0V)								
Itom	Signal	Symbol	Condition	Rat	I.I.m.:4a			
Item	Signai	Symbol	Condition	Min.	Max.	Units		
Address hold time	A0	t _{AH8}		0				
Address setup time		t_{AW8}		0				
System cycle time		$t_{\rm CYC8}$		240				
Enable L pulse width (WRITE)	WR	t _{CCLW}		80				
Enable H pulse width (WRITE)		t _{CCHW}		80				
Enable L pulse width (READ)	חק	t _{CCLR}		140		ns		
Enable H pulse width (READ)	KD	t _{CCHR}		80				
WRITE Data setup time		$t_{\rm DS8}$		40				
WRITE Address hold time	D0 to $D7$	t _{DH8}		0				
READ access time	DU to $D/$	t _{ACC8}	CL = 100 pF		70			
READ Output disable time		t _{OH8}	CL = 100 pF	5	50			



9.2 System bus READ/WRITE characteristics for the 6800 series MPU

(VDD=3.3V, VSS=0V)							
Itom	Signal	Symbol	Condition	Rat	Unita		
Item	Signai	Symbol	Condition	Min.	Max.	Units	
Address hold time	A0	t _{AH6}		0			
Address setup time		t _{AW6}		0			
System cycle time		t _{CYC6}		240			
Enable L pulse width (WRITE)	WR	$t_{\rm EWLW}$		80			
Enable H pulse width (WRITE)		$t_{\rm EWHW}$		80			
Enable L pulse width (READ)	חפ	t _{EWLR}		80		ns	
Enable H pulse width (READ)	KD	$t_{\rm EWHR}$		140			
WRITE Data setup time		t _{DS6}		40			
WRITE Address hold time	D0 to $D7$	t _{DH6}		0			
READ access time	DU to D/	t _{ACC6}	CL = 100 pF		70		
READ Output disable time		t _{OH6}	CL = 100 pF	5	50		



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9.3 The Serial Interface

Itom	Signal	Symbol	Condition	Rat	Linita	
Item	Signai	Symbol		Min.	Max.	Units
Serial Clock Period		t _{SCYC}		50		
SCL "H" pulse width	SCL	t _{SHW}		25		
SCL "L" pulse width		$t_{\rm SLW}$		25		
Address setup time	A0	t _{SAS}		20		
Address hold time		t _{SAH}		10		ns
Data setup time	CI.	t _{SDS}		20		
Data hold time	51	t _{SDH}		10		
CS-SCL time	CS	t _{CSS}		20		
CS-SCL time		t _{CSH}		40		



(VDD=3.3V,VSS=0V)

(Note) *: disabled data

10. COMMAND TABLE

Command	Command Code										Function			
Command	A 0	/RD	/WR	D7	D6	D5	D4	D3	D2	D1	D0	Function		
(1) Display ON/OFF	0	1	0	1	0	1	0	1	1	1	0	LCD display ON/OFF 0: OFE_1: ON		
(2) Display start line set	0	1	0	0	1	Di	spla	ay sta	art a	ddre	ISS	Sets the display RAM display start line address		
(3) Page address set	0	1	0	1	0	1	1	Pa	ge a	ddre	ess	Sets the display RAM page address		
(4) Column address set	0	1	0	0	0	0	1	Mos	st sig	gnific	cant	Sets the most significant 4 bits of		
upper bit Column address set lower bit	0	1	0	0	0	0	0	Lea colu	ımn st si ımn	add gnifi add	ress icant ress	Sets the least significant 4 bits of the display RAM column address.		
(5) Status read	0	0	1		St	atus		0	0	0	0	Reads the status data		
(6) Display data write	1	1	0	Write data							Writes to the display RAM			
(7) Display data read	1	0	1	Read data							Reads from the display RAM			
(8) ADC select	0	1	0	1	0	1	0	0	0	0	0 1	Sets the display RAM address SEG output correspondence 0: normal, 1: reverse		
(9) Display normal/ reverse	0	1	0	1	0	1	0	0	1	1	0 1	Sets the LCD display normal/ reverse 0: normal, 1: reverse		
(10) Display all points ON/OFF	0	1	0	1	0	1	0	0	1	0	0 1	Display all points 0: normal display 1: all points ON		
(11) LCD bias set	0	1	0	1	0	1	0	0	0	1	0 1	Sets the LCD drive voltage bias ratio 0: 1/9 bias, 1: 1/7 bias (ST7565P)		
(12) Read/modify/write	0	1	0	1	1	1	0	0	0	0	0	Column address increment At write: +1 At read: 0		
(13) End	0	1	0	1	1	1	0	1	1	1	0	Clear read/modify/write		
(14) Reset	0	1	0	1	1	1	0	0	0	1	0	Internal reset		
(15) Common output mode select	0	1	0	1	1	0	0	0 1	*	*	*	Select COM output scan direction 0: normal direction 1: reverse direction		
(16) Power control set	0	1	0	0	0	1	0	1	Op mo	Operating mode		Select internal power supply operating mode		
(17) Vo voltage regulator internal resistor ratio set	0	1	0	0	0	1	0	0	Re ra	sista tio	or	Select internal resistor ratio(Rb/Ra) mode		
(18) Electronic volume mode set Electronic volume register set	0	1	0	1 0	0 0	0 Ele	0 ctro	0 nic v	0 olun	0 ne va	1 alue	Set the Vo output voltage electronic volume register		
(19) Static indicator ON/OFF	_		_	1	0	1	0	1	1	0	0	0: OFF, 1: ON		
Static indicator register set	U	1	U	0	0	0	0	0	0	01	1 Mode	Set the flashing mode		
(20) Booster ratio set	0	1	0	1 0	1 0	1 0	1 0	1 0	0 0	0 stej va	0 o-up lue	select booster ratio 00: 2x,3x,4x 01: 5x 11: 6x		
(21) Power saver												Display OFF and display all points ON compound command		
(22) NOP	0	1	0	1	1	1	0	0	0	1	1	Command for non-operation		
(23) Test	0	1	0	1	1	1	1	×	*	*	*	Command for IC test. Do not use this command		

11. LCD MODULES HANDLING PRECAUTIONS

- The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- If the display panel is damaged and the liquid crystal substance inside it leaks out, do not get any in your mouth. If the substance come into contact with your skin or clothes promptly wash it off using soap and water.
- Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarize carefully.
- To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

-Be sure to ground the body when handling the LCD module.

-Tools required for assembly, such as soldering irons, must be properly grounded.

-To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.

-The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

■ Storage precautions

When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps. Keep the modules in bags designed to prevent static electricity charging under low temperature / normal humidity conditions (avoid high temperature / high humidity and low temperatures below 0° C). Whenever possible, the LCD modules should be stored in the same conditions in which they were shipped from our company.

12. OTHERS

- Liquid crystals solidify at low temperature (below the storage temperature range) leading to defective orientation of liquid crystal or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subjected to a strong shock at a low temperature.
- If the LCD modules have been operating for a long time showing the same display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. Abnormal operating status can be resumed to be normal condition by suspending use for some time. It should be noted that this phenomena does not adversely affect performance reliability.
- To minimize the performance degradation of the LCD modules resulting from caused by static electricity, etc. exercise care to avoid holding the following sections when handling the modules :
 - Exposed area of the printed circuit board
 - Terminal electrode sections